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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon NPN Triple Diffused

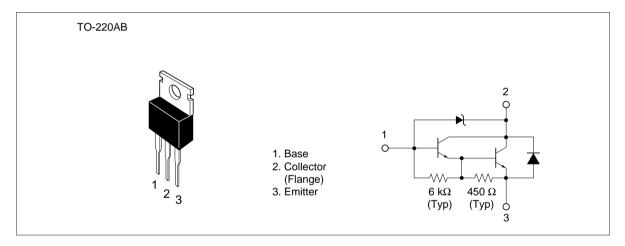


ADE-208-903 (Z) 1st. Edition September 2000

Application

Igniter

Outline



Absolute Maximum Ratings (Ta = 25°C)

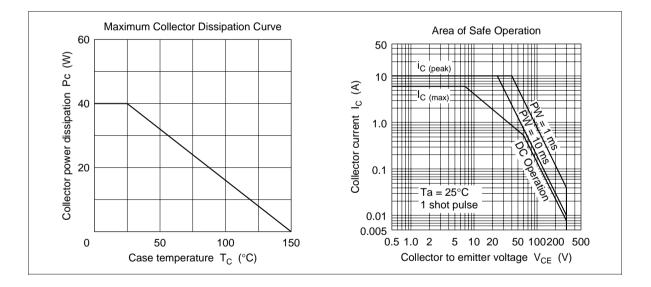
V _{CBO}		
CDO	300	V
V _{CEO} 300		V
V _{EBO}	7	V
Ι _c	6	А
I _{C(peak)}	10	А
P _c * ¹	40	W
Tj	150	°C
Tstg	-55 to +150	°C
	V _{EBO} I _C I _{C(peak)} P _C * ¹ Tj	V _{EBO} 7 I _C 6 I _{C(peak)} 10 P _C *1 40 Tj 150

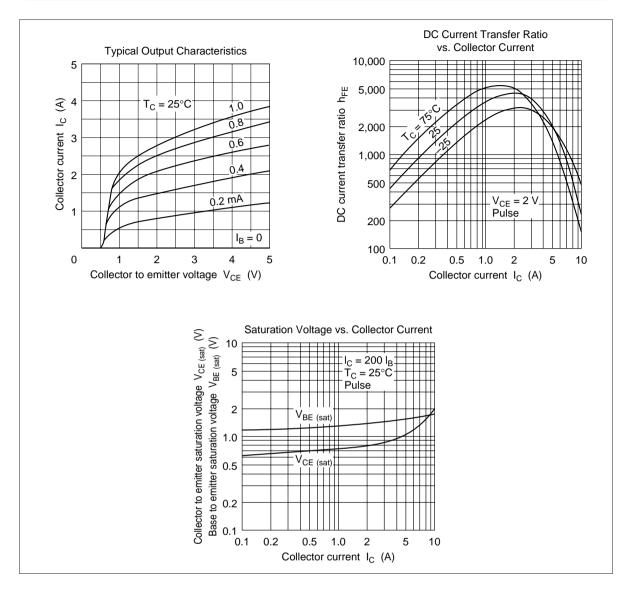
Note: 1. Value at $T_c = 25^{\circ}C$.

Electrical Characteristics (Ta = 25° C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	300	_	500	V	$I_{c} = 0.1 \text{ mA}, I_{E} = 0$
Collector to emitter sustain voltage	$V_{\text{CEO(sus)}}$	300	_	_	V	I _c = 3 A, PW = 50 μs, f = 50 Hz, L = 10 mH
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	_	_	V	$I_{\rm E} = 50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I _{CEO}	_		100	μΑ	V_{ce} = 300 V, R_{be} = ∞
DC current transfer ratio	h _{FE}	500	_	_		$V_{ce} = 2 V, I_c = 4 A^{*1}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	_	1.5	V	$I_{c} = 4 \text{ A}, I_{B} = 40 \text{ mA}^{*1}$
Base to emitter saturation voltage	$V_{\text{BE(sat)}}$	—	—	2.0	V	$I_{\rm c} = 4$ A, $I_{\rm B} = 40$ mA ^{*1}
Turn on time	t _{on}	—	2.0		μs	$I_{\rm C} = 4$ A, $I_{\rm B1} = -I_{\rm B2} = 40$ mA
Turn off time	t _{off}	_	23		μs	$I_{\rm C} = 4$ A, $I_{\rm B1} = -I_{\rm B2} = 40$ mA

Note: 1. Pulse test.





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